Introduction of Ultra-High-Throughput Design and **Prototyping Technology for Ultra-Advanced Materials Development Project (U2M)**

Research Association of High-Throughput Design and **Development for Advanced Functional Materials** (ADMAT)

National Institute of Advanced Industrial Science and Technology (AIST)





Target and Output of U2M PJ

<Target>

In our National Project, we develop a data-based material design scheme for **organic materials** on the basis of advanced computational simulation, artificial intelligence (AI) and experiments such as innovative material processing and advanced characterization. It will replace the traditional material development protocol ever based on hunch and experience with an AI based one, which is expected to largely increase **competitiveness of materials industries**.

<Output Aim>

The main focus of this project is to enhance the quality of material data to increase prediction the reliability of AI, which is achieved by the cutting-edge methodology development for computational simulations, high-throughput processing and advanced characterization as well as the combination between theory and experiment. On the basis of these, the cycle number and tact time will be reduced to one-twentieth as compared with present numbers.

Basic Plan by NEDO





Features and Expected Effects of U2M

Features: Computational Science + AI for R&D of Functional Materials

<List of Items for Implementation>

- ✓ Computer Simulator Development for 'in Silico' Prediction of Structure-Property Relation in Organic/Polymer Materials
- ✓ Precise Simulation and Multiscale Simulation for the Prediction.
- ✓ Al based Design of Functional Organic Materials Using Materials Data
- ✓ Materials Data from High-Throughput Processing and Advanced Characterization as well as Computer Simulations

<Expected Effects>

- ✓ Game Changer in Functional Material Development: From Hunch and Experience to Al based Predictions
- ✓ Bringing Competitiveness to Materials Industries





Concept of U2M: Three-in-one efforts: CMD, Processing & Characterization

Atom

Reaction/ **Polymerization** Monomer/ **Polymer**

Higher Order Structure

Polymer Reaction/ Surface Modification

Hybrid **Materials** (Org/Org., Org./Inorg.)

Molding and Foaming Processing

High-Throughput Synthesis



Multiscale Simulators

Computational (CMD)

Material Design

Super Computer

Electron Spectroscopic **Imaging TEM**

Functional Materials Development

Continuous Extruded Foaming

High-Speed/ Innovative Processing

High Speed and Variable Processes **Advanced Nano-Characterization**

Advanced Characterizations of the Relationship between Structure and Function



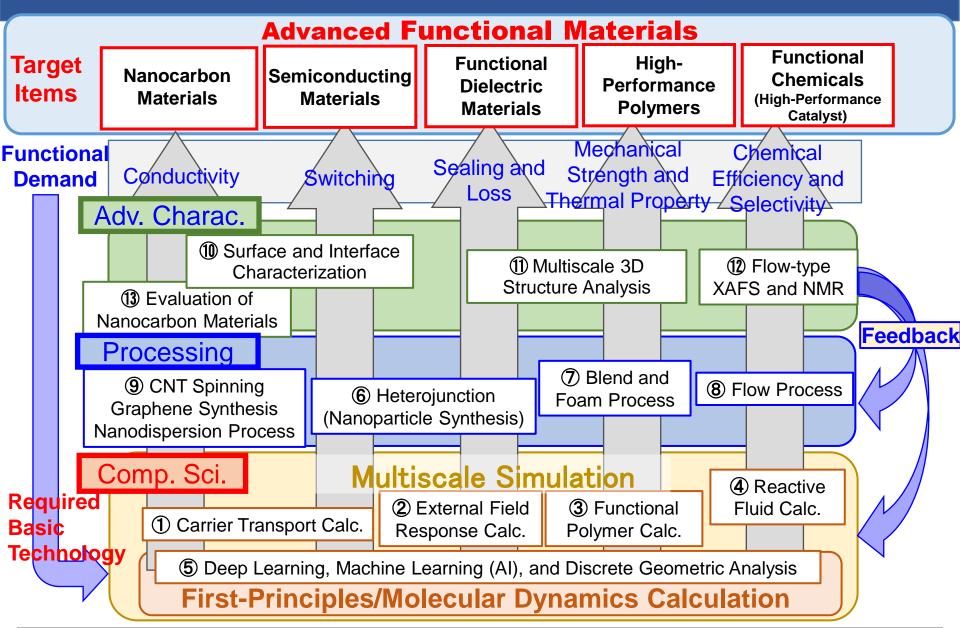
Positron Annihilation

R&D by Orchestration/Collaboration of Simulation/AI, Processing and Characterization





R&D of Advanced Functional Materials by Fundamental Technologies







Assumed Products from U2M Project

Semiconductors

Transparent Thermochromic Film, Organic Semiconductor

In Summer

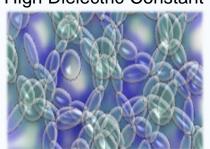
Functional Nanoparticles

Visible Light
Transmission
Nera-IR Cut-Off
In Winter

Visible Light and Near-IR Transmission

Dielectric Materials

Organic/Inorganic Hybrid Condenser with High Voltage Endurance and High Dielectric Constant



High-Performance Polymeric Materials

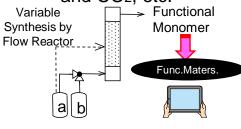
High-Performance Composite Materials, Electronic Materials, etc.

Car Components, etc.



Functional Chemicals (High-Performance Catalyst)

Functional Chemicals and Materials from Natural Products and CO₂, etc.



Display Materials, Functional Rubber Materials, etc.

Nanocarbon Materials (CNT, Graphene)

Light & High-Performance Wire Harness, Electric Cable, Heat Release Materials for Vehicles



Wire Harness, Wiring of Motor for Motorcar



Conductive Rubber, Thermostable Resin, Exothermic Materials, etc.



Flexible Display, Lighting Equipment, etc.





R&D Theme: Linkage for High Speed Development

Atom

Reaction/ Polymerization Monomer/ Polymer Higher Order Structure Polymer Reaction/ Surface Modification Hybrid Materials (Org/Org., Org./Inorg.)

Molding and Forming Processing

Comp. Sci.

Process |

Adv. Charac.

- 1 Multiscale Simulator for Carrier Transport
- 2 Large-scale Simulator for Complex Material and its External Field Response
- 3 Multiscale Simulator for Functional Nano-polymeric Material
- 4 Multiscale Simulator for Reactive Fluid
- 5 Deep Learning, Machine Learning and Discrete Geometric Analysis for Materials Data
- **6** Variable Processes for Heterojunction Materials (Nanoparticle Synthesis)
- **7**Blend and Foam of Polymer Composites
- 8 Flow Reactor for Variable Synthesis (High Throughput)
- ①Structural Characterization of Surface and Interface/Multi Properties Characterization in Nanoscale Area (Sum Frequency Generation Spectroscopy and Nano-Probe)
- 11)Three-dimensional Structure Analysis of Organic (Inorganic) Composite Materials (TEM, Positron Annihilation and X-Ray CT)
- 12 Highly Sensitive in-situ Measurement in Flow Process (XAFS and NMR)
- 13Structure and Property Evaluation of Nanocarbon Materials



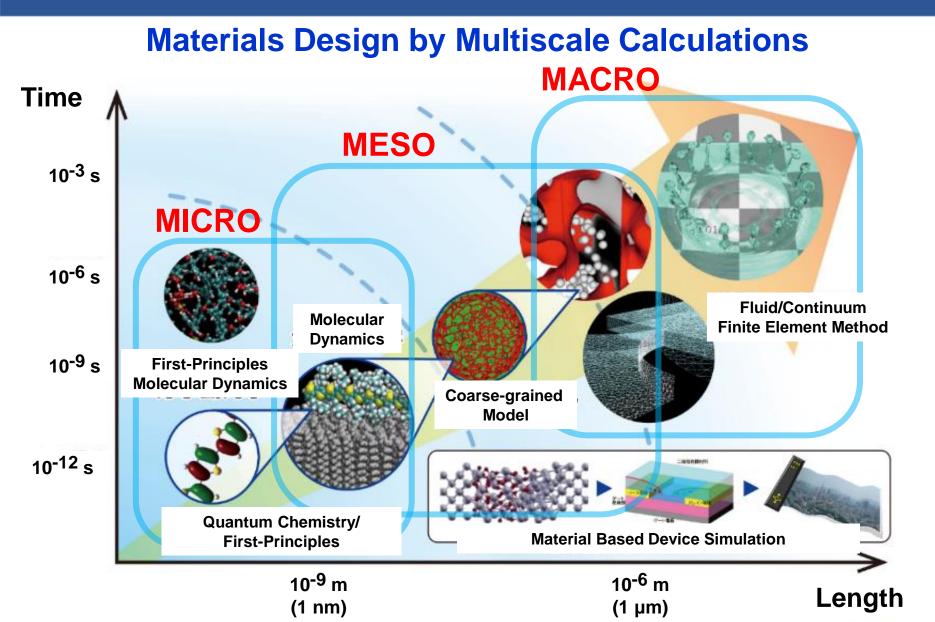


Comp. Sci.-1: R&D of Functional Maters. with Comp. Sci. **Inverse Problem** Comp. Sci. **Multiscale Simulator** Composition/Structure Composition/Structure **MACRO** DB Input **Output** Data **Function** Data **MESO** earning Carrier Transport/ Reactive Fluid Simulator Nanostructured Polymer (Macrodevice, Fluid) Simulator Output Input **Data Data** Nanostructured Polymer **Materials** Αl **MICRO** Simulator 7 **Output** Input Data Data Carrier Transport/External Field Response/Reaction Simulation (First-Principles, Atomic Level) **Micro-Macro Linkage** Feedback





Comp. Sci.-2: Nanostructures Design by Computer

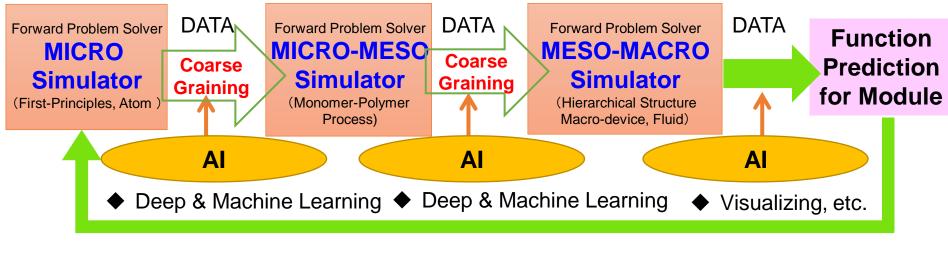


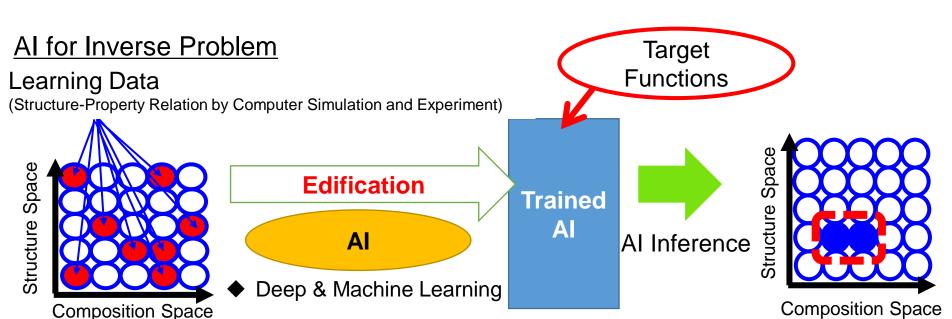




Two Examples of Al Application to Computer Simulation

Al for Forward Problem: Al to Bridge Multiscale Simulations





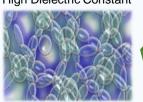




Developed Simulators

Dielectric Materials

Organic/Inorganic Hybrid Condenser with High Voltage Endurance and High Dielectric Constant

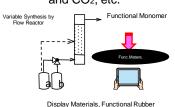


- Carrier Transport Simulator (Extended-CONQUEST)
- Interfacial Dynamics of Atoms and Reaction Simulator(I) (ESM-RISM)
- Interfacial Dynamics of Atoms and Reaction Simulator (II) (HybridQMCLT)
- Monte Carlo Full-Band Device Simulator
- External Field Response Simulator
- Voltage-Controlled Coarse Grained Molecular Dynamics Simulator (I, II) (Extended-COGNAC, LAMMPS)
- Multi-Task Interface (Extended-OCTA)
- Filler-Polymer Composite Simulator (Extended-KAPSEL)
- Nanocarbon Composite Simulator (SOBA)
- Reactive Fluid Simulator



Functional Chemicals (High-Performance Catalyst)

Functional Chemicals and Materials from Natural Products and CO₂, etc.



Materials, etc.

Semiconductors

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Conductive Rubber, Thermostable Resin, Exothermic Materials, etc.



Flexible Display, Lighting Equipment, etc.



High-Performance Composite Materials, Electronic Materials, etc.

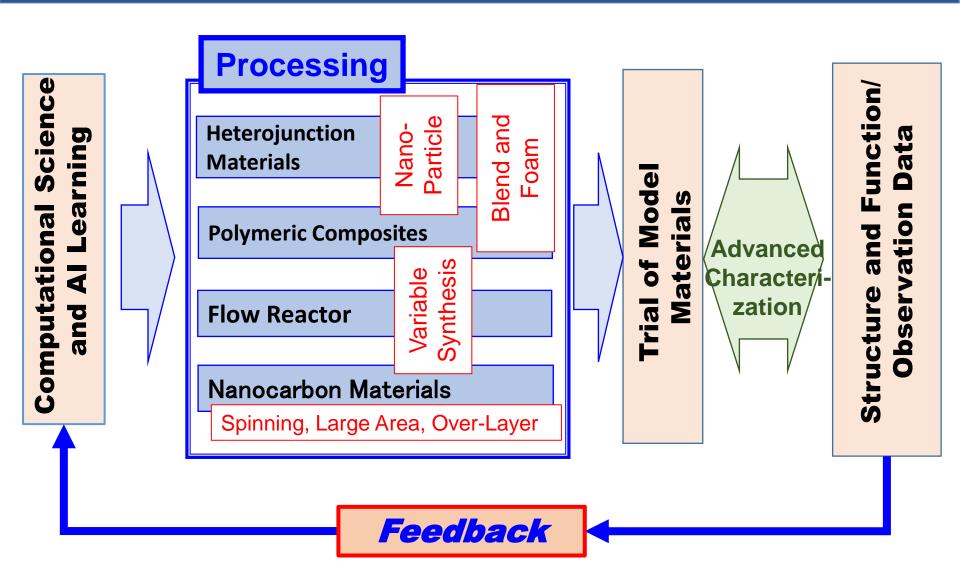
Car Components, etc.







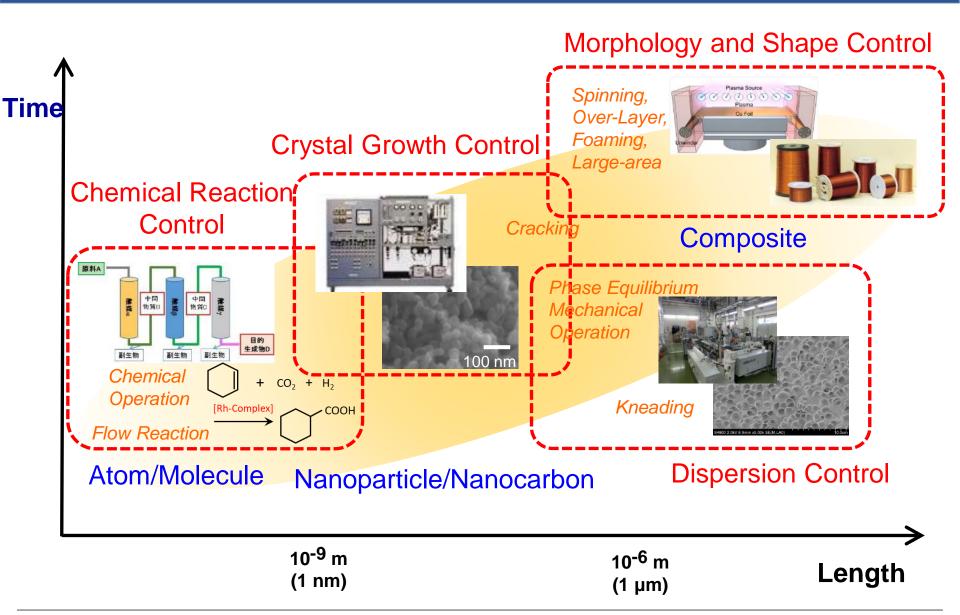
Process-1: Process Engineering and R&D for Functional Materials







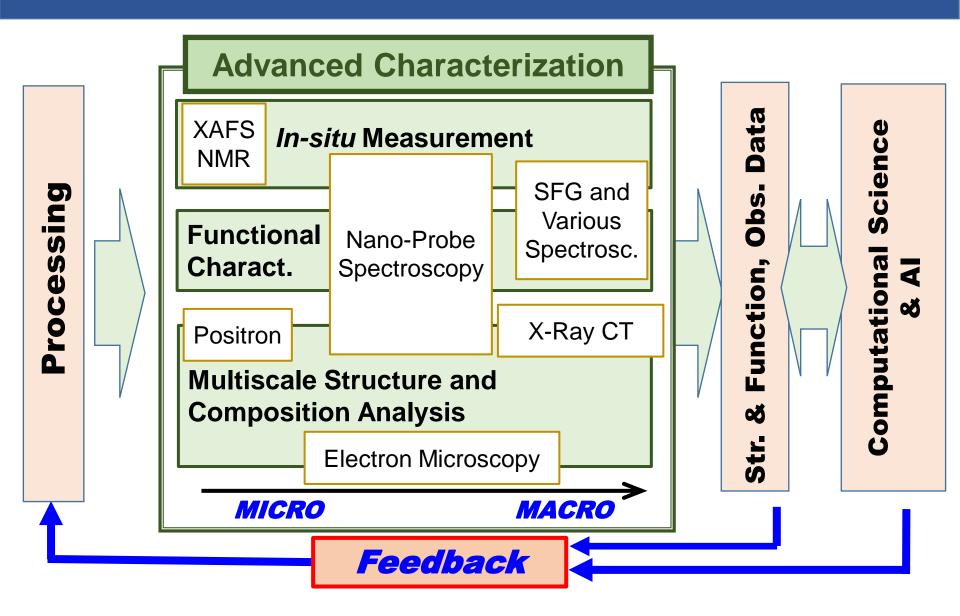
Process-2: High-Throughput and Innovative Processing







Adv. Charact.-1: Adv. Charact. and R&D for Functional Maters.

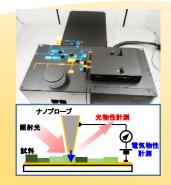




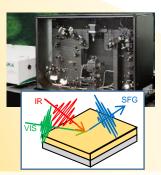


Adv. Charact.-2: Nano Characterization and Evaluation

Nano-Probe Spectroscopy



SFG Spectroscopy



Chemical Reaction In-situ Measurement

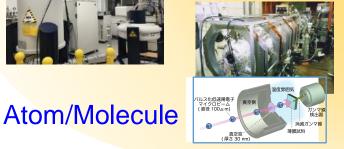
Flow-Type XAFS

Characterization of Structure-Function Correlation

Multiscale Structure-Composition Analysis

DNP-NMR

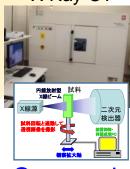
Positron Annihilation



ESI-TEM



X-Ray CT



Composite

Nanostructure, Nanoparticle and Nanocarbon

10⁻⁹ m (1 nm)

10⁻⁶ m (1 μm)

Length





Materials Structure Design and Cooperation of Comp. Sci., Process and Charact. **Multiscale 3D Structure Analysis** Time **Morphology and Shape Control Energy** Spinning, Over-Layer, Foaming, Large-Area In-situ **Dispersion/Orientation/** Measurement Interface Structure Control Nanoparticle **Chemical Reaction Hybrid Materials Composite** Surface Control Dispersion Control Modification Phase Equilibrium, Chemical Operation/Flow Reaction Mechanical Operation Cracking & Kneading Monomer/Polymer Nano Particle, Nano Carbon Coarse-grained Model Fluid/Continuum Finite Element Method Atom/Reaction Quantum Chemistry/ **MACRO MESO** First-Principles/MD <Physical Property Control> < Function Control > **MICRO** Heat Transfer/Conductivity, Thermal Response, Thermal Insulation, Shading, Elastic Modulus, Dielectric Constant High Strength, Thermostable, High Voltage Endurance, etc. **Multi Properties Observation of Nanoscale Area (Function Evaluation)** Length

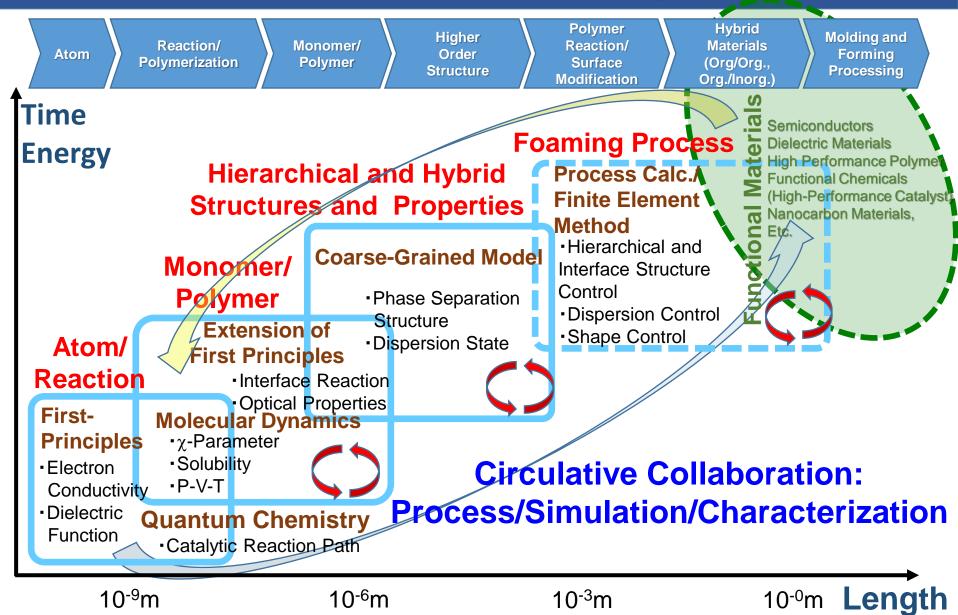
_____10⁻⁶ m (1 μm) _____10⁻³m (1 mm)



10⁻⁹ m (1 nm)



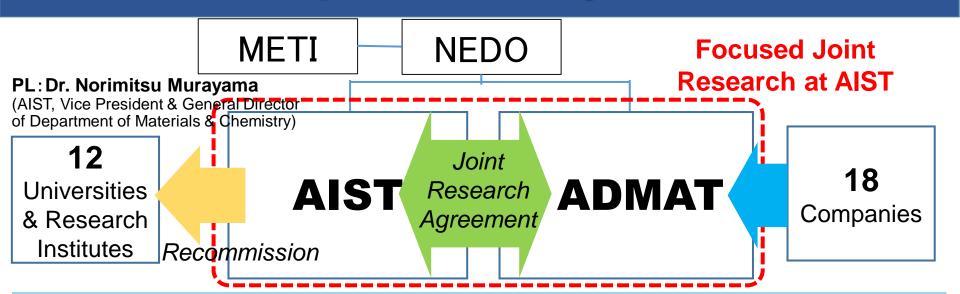
Future Image: High Throughput Design of Functional Materials by Three-in-one efforts: Simulation, Processing & Characterization







Implementation System



Research Association of High-Throughput design and Development for Advanced Functional Materials (ADMAT)

- Establish: July 12, 2016
- President: Kunihiro Koshizuka (KONICA MINOLTA, INC., Senior Technical Advisor)
- Member (18 Companies): Idemitsu Kosan Co., Ltd., Ube Industries, Ltd., KANEKA CORPORATION, KONICA MINOLTA, INC., JSR Corporation, Showa Denko K.K., Showa Denko Materials Co., Ltd., Sekisui Kasei Co., Ltd., DIC Corporation, Tosoh Corporation, Toray Industries, Inc., NIPPON STEEL Chemical & Material Co., Ltd., NIPPON SHOKUBAI CO., LTD., Zeon Corporation, Panasonic Corporation, Furukawa Electric Co., Ltd., Murata Manufacturing Co., Ltd., The Yokohama Rubber Co., Ltd.





Annual Plan

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Mid-Te

FY 2016

FY 2017

FY 2018

FY 2019

FY 2020

FY 2021

Establishing the Elements of the Material Design (MD)

Establishing the Orchestration Scheme for the Elements to Model Materials

Further Improvement of the M.D. Elements

Autonomous Development of Functional Materials

<Contracted Research and Development>

R&D Computational Theme **Material Design (1) High-Throughput** R&D and High-Precision Theme **Manufacturing (2) Process** R&D **High-Throughput** and High-Resolution Theme Characterization (3)

Establishing the Elements of MD

Orchestration / Collaboration among (1), (2) and (3)

Validation and Application of the MD Protocol to Accelerate Model Materials Development

- Augmenting Material Function Prediction Software Module (Optimum Search, etc.)
- High-Throughput Experiments based on Automated Material Process and Characterization
- Validation of the AI based Material Design

<Grant Development>

Grant Theme (4) Functional Materials
Development using the
Computational Material Design





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Ex-Post Evaluation

Future Efforts and Perspective for Application of Results

The

Core of the Material Design Center

Materials Design Platform

Computational Material Design (CMD)

High Speed/ Innovative Process Advanced Nano-Characterization

Orchestration of the Three Material Design Elements

On-Demand Material Data

Data Platform

(Data Manipulation, Analysis and Management, etc.)

Al Technology

Recipes for New Functional Materials

Closed: Priority Use by ADMAT Partners

DESIGN TECHNOLOGY

Computational Material Design Protocol

- Innovative Process
- Advanced Characterization

Softwares to be Opened

SIMULATORS

Computational Simulation

EXPRIMENTAL EQUIPMENTS

AIST Local

- Innovative Process
- Advanced Characterization

AIST to be Material Design Center
Offering Design Protocols and Rules to
Industries in Some Ways as Follows:

- Consortium
- Cooperative Research
- Consulting
- Joint Facilities, etc.



